SN54ACT16244, 74ACT16244 **16-BIT BUFFERS/LINE DRIVERS** WITH 3-STATE OUTPUTS SCAS116B - MARCH 1990 - REVISED APRIL 1996

SN54ACT16244 . . . WD PACKAGE **Members of the Texas Instruments** 74ACT16244 . . . DGG OR DL PACKAGE *Widebus*[™] Family (TOP VIEW) Inputs Are TTL-Voltage Compatible 48 20E 3-State Outputs Drive Bus Lines or Buffer 1OE Memory Address Registers 1Y1 2 47 1A1 1Y2 🛛 3 46 🛛 1A2 Flow-Through Architecture Optimizes 45 🛛 GND GND 4 **PCB** Layout 1Y3 **[**5 44 🛛 1A3 Distributed V_{CC} and GND Pin 43 **1**A4 1Y4 6 **Configurations Minimize High-Speed** V_{CC} []7 42 VCC Switching Noise 2Y1 8 41 2A1 **EPIC[™]** (Enhanced-Performance Implanted 40 **2**A2 2Y2 9 CMOS) 1-um Process GND 110 39 GND 500-mA Typical Latch-Up Immunity at 2Y3 11 38 2A3 125°C 1 • **Package Options Include Plastic Shrink** Small-Outline (DL) and Thin Shrink 2 Small-Outline (DGG) Packages, and 380-mil D Fine-Pitch Ceramic Flat (WD) Packages 3 Using 25-mil Center-to-Center Pin Spacings 1 description The SN54ACT16244 and 74ACT16244 are 16-bit D

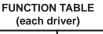
buffers/line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. They can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. The devices provide true outputs and symmetrical \overline{OE} (active-low) output-enable inputs.

2Y4	12	37] 2A4
3Y1	13	36] 3A1
3Y2	14	35] 3A2
GND	15] GND
3Y3	16	33] 3A3
3Y4	[17] 3A4
V _{CC}	18	31] V _{CC}
4Y1		30] 4A1
4Y2	20	29] 4A2
GND	21	28] GND
4Y3	22	27] 4A3
4Y4	23] 4A4
4OE	24	25] 3 <mark>0</mark> E

The 74ACT16244 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ACT16244 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16244 is characterized for operation from -40°C to 85°C.

(each driver)										
INP	JTS	OUTPUT								
OE	Α	Y								
L	Н	Н								
L	L	L								
н	Х	Z								





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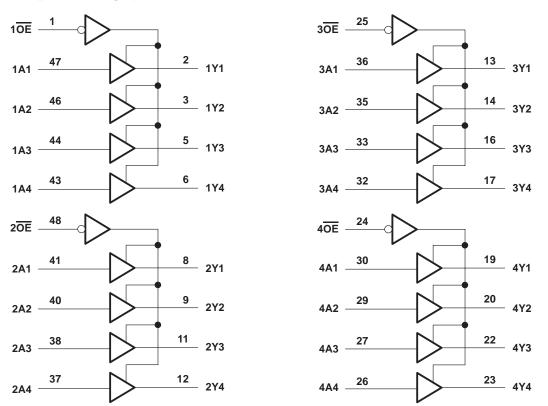
logic symbol[†]

					1	
1 <mark>0E</mark>	1	EN1				
2 <mark>0</mark> E	48	EN2				
3 <mark>0E</mark>	25	EN3				
4 <u>0</u> E	24	EN4				
40E						
1A1	47	┍┸━━	1	1▽	2	1Y1
1A2	46	<u> </u>		• •	3	1Y2
1A3	44	<u> </u>			5	1Y3
1A4	43				6	1Y4
2A1	41	<u> </u>	1	2 ▽	8	2Y1
2A1 2A2	40	<u> </u>		~ ~	9	211 2Y2
2A2 2A3	38	┣───			11	
	37	 			12	2Y3
2A4	36		1	3 ▽	13	2Y4
3A1	35	┣───	1	3 ∨	14	3Y1
3A2	33	┣───			16	3Y2
3A3	32	┣───			17	3Y3
3A4	30			4	19	3Y4
4A1	29	 	1	4 ▽	20	4Y1
4A2	27	 			22	4Y2
4A3	26	 			23	4Y3
4A4						4Y4

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	–0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2): DGG package .	0.85 W
DL package	1.2 W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.



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recommended operating conditions (see Note 3)

		SN54AC	Г16244	74ACT	16244	UNIT
		MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage (see Note 4)	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
VIL	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	VCC	0	VCC	V
VO	Output voltage	0	VCC	0	VCC	V
ЮН	High-level output current		-24		-24	mA
IOL	Low-level output current		24		24	mA
$\Delta t / \Delta v$	Input transition rise or fall rate	0	10	0	10	ns/V
т _А	Operating free-air temperature	-55	125	-40	85	°C

NOTES: 3. Unused inputs should be tied to V_{CC} through a pullup resistor of approximately 5 k Ω or greater to prevent them from floating.

4. All V_{CC} and GND pins must be connected to the proper voltage supply.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		т	₄ = 25°C	;	SN54AC	Г16244	74ACT	16244	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	1	4.5 V	4.4			4.4		4.4		
	I _{OH} = -50 μA	5.5 V	5.4			5.4		5.4		
Vou	I _{OH} = -24 mA	4.5 V	3.94			3.7		3.8		V
VOH	10H = -24 mA	5.5 V	4.94			4.7		4.8		v
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85		
	1	4.5 V			0.1		0.1		0.1	
	I _{OL} = 50 μA	5.5 V			0.1		0.1		0.1	
	1	4.5 V			0.36		0.5		0.44	V
VOL	I _{OL} = 24 mA	5.5 V			0.36		0.5		0.44	v
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65			
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V							1.65	
Ц	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μA
I _{OZ}	$V_{O} = V_{CC}$ or GND	5.5 V			±0.5		±10		±5	μA
ICC	$V_{I} = V_{CC} \text{ or GND}, I_{O} = 0$	5.5 V			8		160		80	μA
ΔI_{CC}^{\ddagger}	One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V			0.9		1		1	mA
Ci	$V_I = V_{CC}$ or GND	5 V		4.5						pF
Co	$V_{O} = V_{CC}$ or GND	5 V		13.5						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[‡]This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	Т	λ = 25°C		MIN	MAX	UNIT
		(001101)	MIN	TYP	MAX	WIIN	IVIAA	
^t PLH	A	V	4	6.5	8.5	3	10.3	ns
^t PHL			3.4	6.3	8.7	3.4	10.1	115
^t PZH	OE	V	3	5.8	8.1	3	10.5	-
tPZL	ÛE	T	3.7	6.7	9.3	3.7	11	ns
^t PHZ	ŌĒ	V	5.4	8.1	11.5	5.4	13	ns
^t PLZ	UE	I	5	7.5	9.5	5	10.9	115

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	Т	₄ = 25°C	;	MIN	MAX	UNIT
	(INI 01)	(001101)	MIN	TYP	MAX	IVIIIN	WAA	
^t PLH	A	V	4	6.5	8.5	4	9.4	ns
^t PHL		T	3.4	6.3	8.7	3.4	9.5	115
^t PZH	ŌĒ	V	3	5.8	8.1	3	8.9	20
^t PZL	UE	Ι	3.7	6.7	9.3	3.7	10.3	ns
^t PHZ	ŌĒ	V	5.4	8.1	10.3	5.4	11.3	ns
tPLZ	UE		5	7.5	9.5	5	10.3	115

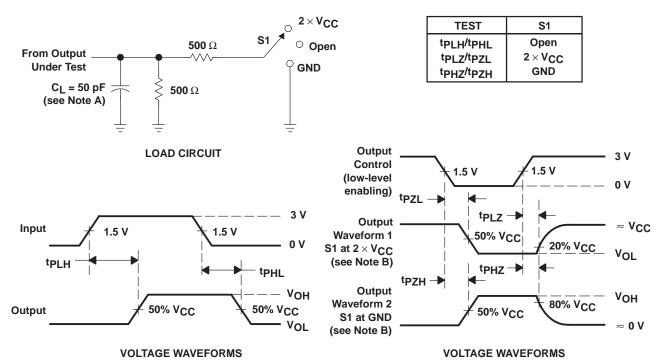
operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CON	TYP	UNIT		
C _{pd} Power dissipation of	Dower discipation conscitance	Outputs enabled	C _I = 50 pF,	f = 1 MHz	39	ъE
		Outputs disabled	CL = 50 pF,		11	рF



SN54ACT16244, 74ACT16244 16-BIT BUFFERS/LINE DRIVERS WITH 3-STATE OUTPUTS

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PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

- Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_r = 3 ns, t_f = 3 ns.

D. The outputs are measured one at a time with one input transition per measurement.





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9202201MXA	ACTIVE	CFP	WD	48	1	TBD	A42 SNPB	N / A for Pkg Type
74ACT16244DGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ACT16244DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ACT16244DGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ACT16244DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ACT16244DLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ACT16244DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ACT16244DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54ACT16244WD	ACTIVE	CFP	WD	48	1	TBD	A42 SNPB	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*	All dimensions are nominal												
	Device	•	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	74ACT16244DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
	74ACT16244DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
74ACT16244DGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0
74ACT16244DLR	SSOP	DL	48	1000	346.0	346.0	49.0

MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



MECHANICAL DATA

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

DL (R-PDSO-G**)



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118



MECHANICAL DATA

MCFP010B - JANUARY 1995 - REVISED NOVEMBER 1997

CERAMIC DUAL FLATPACK

WD (R-GDFP-F**)

48 LEADS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only
 - E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA
 - GDFP1-F56 and JEDEC MO-146AB



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